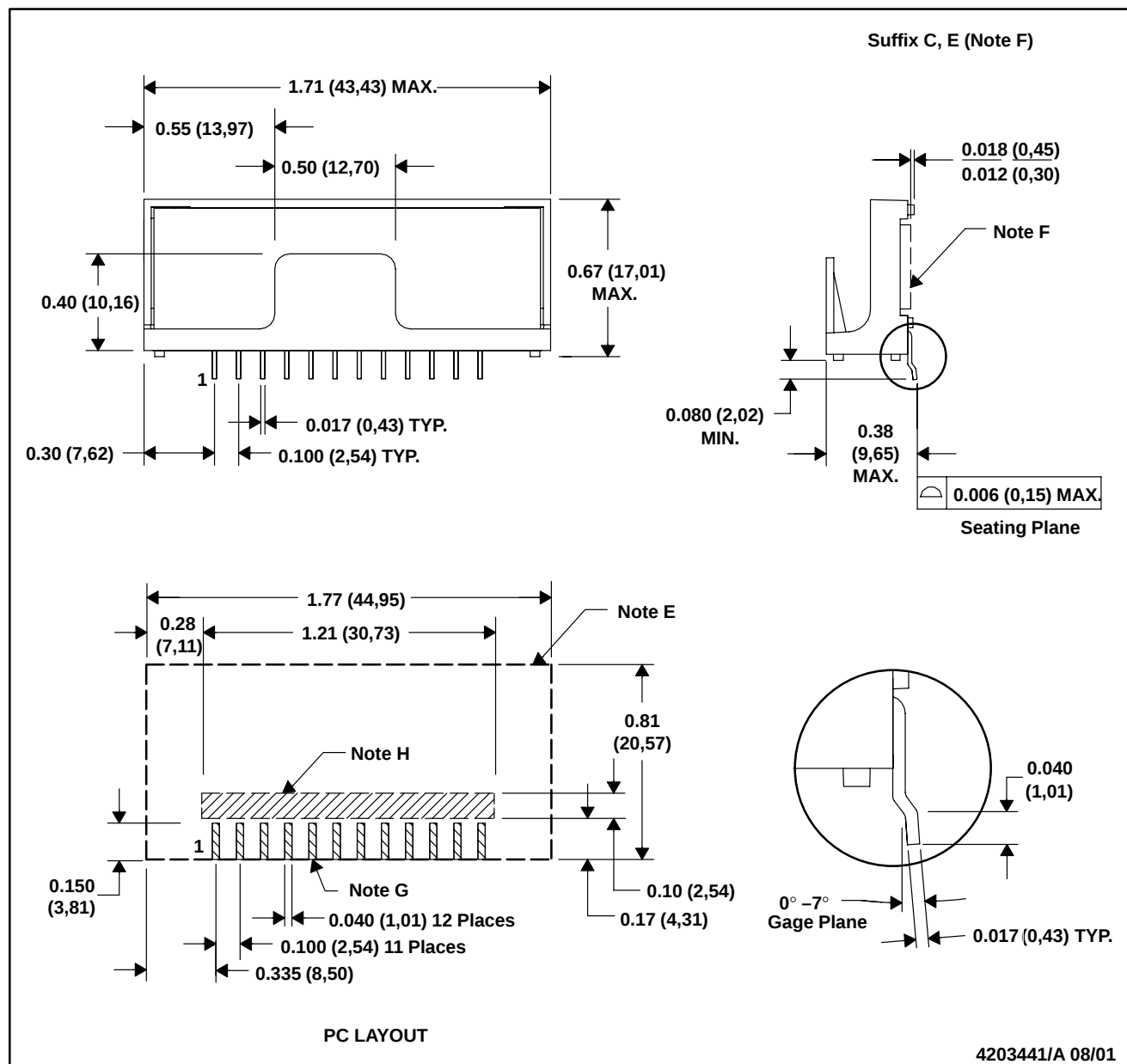


EBC (R-PSIP-G12)

PLASTIC SINGLE-IN-LINE MODULE



- NOTES:
- A. All linear dimensions are in inches (mm).
 - B. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 - D. 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 - E. Recommended mechanical keep-out area.
 - F. E-suffix parts include a metal heat spreader. No signal traces are allowed under the heat spreader area. A solid copper island is recommended, which may be grounded. C-suffix parts do not include a metal heat spreader.
 - G. Power pin connections should utilize two or more vias per input, ground and output pin.
 - H. No copper, power or signal traces in this area.

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